Note: All 27 Ohm resistor are 5%, 0.1W
Values of R261 and R259 have to be calculated. R260 is a pullup resistor in the 100kOhm to 1MOhm range. Refer to TPS60210 datasheet.

Note: U30 can be replaced with U29 if desired. Both have the same footprint.
RF card seen from TOP. (Connector Mounted on the BOTTOM) The connectors are spaced 1200mils center to center and are pushed all the way at the bottom on the card outline. Card is 1500x1200mils.
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